

**REGULATOR DESIGN FOR INDUCTIVE BOOSTER PUMP USING
PULSE WIDTH MODULATION TECHNIQUE**

CROSS REFERENCE TO A RELATED APPLICATION

- 5 This application is related to Patent Application entitled "In-Package Inductive Charge Pump Circuit for Providing Voltages Useful for Flash Memory and Other Applications," filed on the same date as the application.

Field of the Invention

- 10 This invention relates generally to direct current (DC) voltage boosting circuits, and in particular, to a DC voltage boosting circuit that includes a resolution circuit that produces a control signal for the boosting circuit that is pulse-width modulated by the output voltage of the boosting circuit.

15 BACKGROUND OF THE INVENTION

- Many applications require circuits that can boost up an input power supply DC voltage to a higher DC voltage used for specialized operations. The reason for the voltage boost up is that often only standardized power supply voltages are available for supplying power to electronic circuits. However, there may situations where a circuit needs a higher
20 voltage than one available from the associated power supply. One example of such a circuit is an electrical erasable programmable read only memory (EEPROM), typically termed in the art as "flash memory."

- A flash memory generally comprises an array of memory cells each typically storing a bit of digital information. Often, a memory cell is merely a field effect transistor
25 (FET) that includes a floating gate which holds a charge that corresponds to a bit of digital information (termed herein as a "bit charge"). More specifically, a memory cell FET comprises a drain, gate, and a source, wherein the gate includes a control gate for enabling reading, writing, and erasing operations on the cell, and a floating gate for storing the bit charge of digital information. In addition to these gates, some memory cells include an
30 erase gate used for removing the bit charge from the floating gate, thereby erasing the memory cell.

 The writing (i.e. programming) of a bit charge of digital information typically involves electrons that tunnel or inject from the FET channel through the thin gate oxide to

the floating gate. Generally, the tunneling effect or hot electron injection requires relatively high energy to move the electrons across the gate oxide layer. Similarly, the removing of electrons from the floating gate during an erase procedure requires relatively high energy to move the electrons across the gate oxide or an oxide situated between the erase and floating gates. The source for the high energy for both the writing and erasing operations is typically a relatively high voltage source, which is higher than the power supply voltages used for memory control operations. For example, the voltage required for writing and reading operations may be on the order of six (6) volts, whereas the voltage for the memory control normal operations may be on the order of 1.5 volts.

In a typical flash memory circuit, the majority of the circuit operations require a voltage on the order of 1.5 volts, for example. Thus, the design of the power supply for the flash memory circuit includes a 1.5 volt power supply. However, to generate the higher voltage used for writing and erasing operations, a DC voltage boost circuit is used which takes the normal power supply voltage of 1.5 volts and boosts it up to about six (6) volts to perform these higher voltage operations. In general though, DC voltage boost circuit can convert any input voltage to any desired output voltage.

An example of such a DC voltage boost circuit is a capacitor charge pump circuit which includes a plurality of cascaded stages each comprising a switch and a capacitor. A previous stage in the cascade supplies charges to a next stage in boosting an input voltage to a higher output voltage. However, this type of boost circuit is typically inefficient due to the losses incurred in the transfer of charges between stages, and the losses incurred across each capacitor. The efficiency for a DC voltage boost circuit that includes a capacitor charge pump circuit is on the order of about five (5) to eleven (11) percent.

Thus, there is a need for a DC voltage boost circuit that has improved efficiency in the conversion of a relatively low input voltage to a relatively high input voltage. Such a need is provided for in the new DC voltage boost circuits of the invention, as described below. The DC voltage boost circuits of the invention can be used for flash memory, static and dynamic random access memory (RAM) application, or any other application which may or many not be related to memory applications. In general, there is a need for a DC voltage boost circuit that generates an output voltage from an input voltage.

BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 illustrates a block diagram of an exemplary memory circuit in accordance with the invention;

5 Figure 2 illustrates a block/schematic diagram of an exemplary DC voltage boost circuit in accordance with the invention;

Figure 3 illustrates a block/schematic diagram of an exemplary DC voltage boost circuit that produces multiple output voltages in accordance with the invention;

10 Figure 4 illustrates a block/schematic diagram of yet another exemplary DC voltage boost circuit that produces multiple output voltages in accordance with the invention;

Figure 5A illustrates a top view of an exemplary integrated circuit incorporating a DC voltage boost circuit in accordance with the invention;

Figure 5B illustrates a top view of another exemplary integrated circuit incorporating a DC voltage boost circuit in accordance with the invention;

15 Figure 6 illustrates a block diagram of an exemplary electronic unit in accordance with the invention;

Figure 7A illustrates a block/schematic diagram of an exemplary regulation circuit for a booster pump in accordance with the invention;

20 Figure 7B illustrates the waveforms involved in the pulse width modulating process of the pulse width modulator of Figure 7A;

Figure 8A illustrates a block/schematic diagram of another exemplary regulation circuit for a booster pump in accordance with the invention;

Figure 8B illustrates the waveforms involved in the pulse width modulating process of the pulse width modulator of Figure 8A;

25 Figure 9A illustrates a block/schematic diagram of yet another exemplary regulation circuit for a booster pump in accordance with the invention;

Figure 9B illustrates a binary truth table involved in the pulse width modulating process of the pulse width modulator of Figure 9A; and

30 Figure 9C illustrates the waveforms involved in the pulse width modulating process of the pulse width modulator of Figure 9A.

DETAILED DESCRIPTION OF THE INVENTION

Figure 1 illustrates a block diagram of an exemplary memory circuit 100 in accordance with the invention. The memory circuit 100 comprises a DC voltage boost circuit 101, a memory operations circuit 106, and one or more memory arrays 130. The DC voltage boost circuit 101 comprises a charge pump 102 and a pump controller 104. 5 The memory operations circuit 106 comprises a reading decoder 112, a writing/erasing decoder 114, and a memory controller 116.

In operation, the charge pump 102 of the DC voltage boost circuit 101 receives a relatively low power supply voltage (V_{cc}) and generates voltages for performing reading, 10 writing, erasing and memory controller operations. These voltages are coupled to the reading decoder 112, the writing/erasing decoder 114, and the memory controller 116 of the memory operations circuit 106 by way of lines 122, 124, and 126, respectively. The pump controller 104 regulates the voltages provided to the memory operations circuit so that they are maintained substantially at constant desired voltages. The voltage provided 15 to the writing/erasing decoder 114 is typically higher than the power supply voltage V_{cc} (e.g. 1 volt), in order to cause the writing and erasing operations. For example, this voltage might be on the order of six (6) volts. Whereas, the voltages for reading and memory control operations are much lower, for example on the order of about 1.5 volts.

The DC voltage boost circuit 101, and all other DC voltage boost circuits described 20 herein, need not be limited to flash memory applications. The DC voltage boost circuits described herein can be used in other applications, including static random access memory (SRAM), dynamic random access memory (DRAM), and other memory applications. In fact, the DC voltage boost circuits described herein need not be limited to memory applications, and can also be used in any other applications that require an output voltage 25 that is different from an input voltage, including wireless, portable computing devices such as personal digital assistants (PDAs), lap top computers, appliances, etc.

Figure 2 illustrates a block/schematic diagram of an exemplary DC voltage boost circuit 200 in accordance with the invention. The DC voltage boost circuit 200 comprises an inductive element 210, a charge pump actuating circuit 212 comprising a switching 30 FET T1 and a diode D1, and an output charging capacitor C2. The DC voltage boost circuit 200 further includes a regulation circuit 222 and a level shifter 220. The DC voltage boost circuit 200 may also include a capacitor C1 situated between V_{cc} and

ground for filtering out noise, spurs and/or other unwanted signals present in the power supply voltage V_{cc} , and a FET T2 situated between V_{cc} and the output of the boost circuit 200 to insure that the output is at a sufficient voltage to energize the level shifter upon start-up.

5 In operation, an oscillating control signal is applied to the gate of the switching transistor T1 which causes the transistor T1 to periodically turn ON and OFF. The turning ON of transistor T1 causes a current to flow from V_{cc} through the inductive charge pump 210 and down to ground through transistor T1. The inductive charge pump 210 stores the energy formed by the current flowing through the inductive element. When the oscillating
10 control signal causes the transistor T1 to turn OFF, the voltage at the drain of the transistor T1 spikes up, which is transferred to the output capacitor C2 by way of diode D1. The transfer of the voltage (i.e. charges) to the output capacitor C2 increases the output voltage of the DC boost converter.

Thus, each cycle of the control signal causes an additional packet of charges to
15 transfer to the output capacitor C2. The diode D1 prevents those charges from flowing backwards through transistor T1 during the next ON cycle of transistor T1. By continuously cycling the control signal, a build up of charges results on the output capacitor C2 until a steady-state voltage results at the output of the boost circuit 200. The steady-state voltage depends on the characteristics of the control signal, including its
20 frequency and duty cycle.

The output of the DC voltage boost circuit 200 is applied to the regulation circuit 222. The regulation circuit 222 develops the control signal used to drive the switching transistor T1 so that a substantially constant desired voltage is maintained at the output of the boost circuit 200. The regulation circuit 222 can perform this in many ways, including
25 by generating a frequency modulated control signal or a pulse width modulated control signal. In the preferred embodiment, a pulse width modulated control signal is generated in accordance with various regulation circuits described in more detail below. The modulated control signal is sent to the level shifter 220 to increase the modulated control signal voltage so that it can drive the transistor T1 into its ON and OFF states. By
30 increasing the drive to transistor T1 using the level shifter 220, the transistor T1 can be made smaller, which results in a savings of die real estate.

This case addresses the control operation of a regulation circuit that produces a frequency modulated control signal. If the output voltage of the boost circuit 200 falls below a desired level, the regulation circuit 222 senses this decrease. In response to sensing a decrease in the output voltage, the regulation circuit 222 increases the frequency of the modulated signal in order to increase the rate of charges delivered to the output capacitor C2. This action increases the voltage at the output of the boost circuit 200 in order to compensate for the initial drop in the output voltage. If, on the other hand, the output voltage of the boost circuit 200 rises above a desired level, the regulation circuit 222 senses this increase, and responsively decreases the frequency of the modulated signal in order to decrease the rate of charges delivered to the output capacitor C2. This action decreases the voltage at the output of the boost circuit 200 in order to compensate for the initial rise in the output voltage.

This case addresses the control operation of a regulation circuit that produces a pulse width modulated control signal. If the output voltage of the boost circuit 200 falls below a desired level, the regulation circuit 222 senses this decrease. In response to sensing a decrease in the output voltage, the regulation circuit 222 increases the duty cycle of the modulated signal in order to increase the packet size of charges delivered to the output capacitor C2. This action increases the voltage at the output of the boost circuit 200 in order to compensate for the initial drop in the output voltage. If, on the other hand, the output voltage of the boost circuit 200 rises above a desired level, the regulation circuit 222 senses this increase, and responsively decreases the duty cycle of the modulated signal in order to decrease the packet size of charges delivered to the output capacitor C2. This action decreases the voltage at the output of the boost circuit 200 in order to compensate for the initial rise in the output voltage.

It has been determined that the DC voltage boosting circuit 200 operates most efficiently if the duty cycle of the pulse width modulated control signal is approximately 75 percent. If the duty cycle is much lower than 75 percent, less energy is stored in the inductor because the time the current is allowed to flow through the inductor is shorter. If the duty cycle is much greater than 75 percent, there is not enough time to allow the stored energy to transfer to the output capacitor. With the optimum duty cycle for the control signal, the DC voltage boost circuit 200 can achieve an efficiency of approximately 70

percent, which is a substantial increase beyond the 5 to 11 percent efficiency seen in prior art boosting circuits.

Figure 3 illustrates a block/schematic diagram of an exemplary DC voltage boost circuit 300 that produces multiple output voltages in accordance with the invention. The boost circuit 300 includes a first boosting circuit for producing a first output voltage (i.e. Output 1, e.g. 6 Volts) comprising a switching transistor T1, diode D1, output capacitor C2, transistor T2, and regulation circuit 322. The boost circuit 300 also includes a second boosting circuit for producing a second output voltage (i.e. Output 2, e.g. 1.55 Volts) comprising a switching transistor T2, switch 344, diode D2, output capacitor C3, regulation circuit 342, and level shifter 340. In addition, the boost circuit 300 further includes an inductive charge pump 310 and capacitor C1 that are common to both the first and second boosting circuits.

The first and second boost circuits operate in a similar fashion as described above with reference to DC boost circuit 200 shown in Figure 2. A switch 344 is provided to the lower voltage boosting circuit to isolate the output 2 when transistor T1 is turned ON. That is, switch 344 is OFF when transistor T1 is turned ON. Also, transistor T2 is turned ON during the OFF time of transistor T1.

Figure 4 illustrates a block/schematic diagram of another exemplary DC voltage boost circuit 400 that produces multiple output voltages in accordance with the invention. The boost circuit 400 includes a first boosting circuit for producing a first output voltage (i.e. Output 1, e.g. 6 Volts) comprising a diode D1, output capacitor C1, transistor T2, and regulation circuit 422. The boost circuit 400 also includes a second boosting circuit for producing a second output voltage (i.e. Output 2, e.g. 1.55 Volts) comprising a switch 444, diode D2, output capacitor C2, and regulation circuit 442. In addition, the boost circuit 400 further includes an input capacitor C, an inductive charge pump L, a switching transistor T1, and a clocking logic 462, common to both the first and second boosting circuits.

The first and second boost circuits operate in a similar fashion as described above with reference to DC boost circuit 200 shown in Figure 2. The outputs of the 6-Volt regulation circuit 422 and the 1.55-Volt regulation circuit 442 are provided to the clocking logic 462. The clocking logic 462 generates a time-division multiplexing control signal comprising the two pulse-width modulation control signals from the regulation circuits

422 and 442 at different time slots. The time-division multiplexing control signal drives the common switching transistor T1. The clocking logic 462 may also include a level shifter that uses the voltage at Output 1 to increase the drive on switching transistor T1 so that the switching transistor T1 can be made smaller, as described above.

5 In operation, during a first phase of the time-division multiplexing control signal, the pulse width modulated control signal generated by the Output 1 regulation circuit 422 drives the switching transistor T1 in order to produce the desired voltage (e.g. 6 Volts) at Output 1. Also in the first phase of the time-division multiplexing control signal, the switch 444 is OFF to isolate the lower voltage Output 2 from the higher voltage generated
10 across transistor T1. During a second phase of the time-division multiplexing control signal, the pulse width modulated control signal generated by the Output 2 regulation circuit 442 drives the switching transistor T1 in order to produce the desired voltage (e.g. 1.55 Volts) at Output 2. Also in the second phase of the time-division multiplexing control signal, the switch 444 is ON to couple the inductive pump and switching transistor
15 T1 to Output 2.

The regulations circuits 422 and 442 receive a clock Clk2 in order to generate therefrom their respective pulse width modulated control signals. Since the switch 444 is only ON for one period of the pulse width modulated signal and off for the other period, it can be clocked with a clock Clk 1 having a frequency half that of Clk2. Likewise, since
20 the clocking logic 462 has to switch between the two pulse width modulated signals, it can also be clocked with clock Clk1.

Figure 5A illustrates a top view of an exemplary integrated circuit 500 incorporating a DC voltage boost circuit in accordance with the invention. The integrated circuit 500 comprises an integrated circuit package 502 including a plurality of leads for
25 connection to external circuitry. The integrated circuit 500 further includes an integrated circuit die 506 situated within the package internal boundary 504 of the integrated circuit package 502. The die 506 in this example incorporates a portion of the DC boost circuit 510 as described above. A plurality of wire bonds or other suitable connection means electrically connects the die circuitry to the package leads. An input capacitor 512, an
30 inductor 514 and/or output capacitor 516 of the DC boost circuit as described above are situated external to the die 506 within the package internal boundary 504. These components can be situated next to a side of the die 506 within the package internal

boundary 504 as shown in Figure 5A, or can be situated on top of the die 506 as well. A plurality of wire bonds or other suitable connection means electrically connect the input capacitor 512, an inductor 514 and/or output capacitor 516 of the DC boost circuit to the remaining portion of the booster circuit 510.

5 There are several advantages for incorporating the input capacitor 512, the inductor 514 and/or the output capacitor 516 of the DC boost circuit into the integrated circuit package 500, but outside of the die 506. First, substantial savings in the die size results from the incorporation of these three elements 512, 514, and 516 outside of the die 504. Second, substantial increase in the efficiency of the DC voltage boost circuit can be
10 achieved by incorporating the inductor 514 outside of the die 506. A reason for this is that the external inductor 514 can be made with a magnetic substrate having a three-dimensional conductive spiral which can achieve higher inductance and higher current carrying capability. These two characteristics improves the efficiency of the DC booster circuit. Third, by incorporating the input capacitor 512, the inductor 514 and/or the output
15 capacitor 516 within the package 502, the DC boost circuit is self contained in the integrated circuit package 502 without requiring external connections to these components.

Figure 5B illustrates a top view of another exemplary integrated circuit 550 incorporating a DC voltage boost circuit in accordance with the invention. Integrated
20 circuit 550 is similar to integrated circuit 500 (Figure 5A), in that it includes an integrated circuit package 552, and an integrated circuit die 556 including a portion of the DC voltage boost circuit 560 situated within an internal boundary 554 of the package 552. The integrated circuit 550 differs from integrated circuit 500 in that at least two of the input capacitor, inductor, and output capacitor can be combined into an integrated
25 substrate 558 instead of having them as three separate components shown in Figure 5A. This feature can make the assembly of the integrated circuit 550 substantially easier and possibly reduce manufacturing cost and time substantially.

Figure 6 illustrates a block diagram of an exemplary electronic unit 600 in accordance with the invention. The electronic unit 600 can be any electronic unit,
30 including an integrated circuit, a circuit board, a module, and/or a sub-module to name a few, that includes a plurality of circuits, such as circuits 1-3 (602, 604, and 606) each of which perform a specific task within the unit. The circuits 1-3 (602, 604, and 606) require

particular supply voltages to operate, such as for example 5 Volts for circuit 1 (602), 3 Volts for circuit 2 (604), and 1 Volt for circuit 3 (606). The electronic unit 600 also includes a plurality of DC voltage boost circuits, such as DC voltage boosts 1-3 (608, 610, and 612) for supplying the proper supply voltages outputs 1-3 (e.g. 5 Volts, 3 Volts, and 1 Volt) respectively to the circuits 1-3 (602, 604, and 606). The DC voltage boosts 1-3 (608, 610, and 612) receive a common input voltage for generating their respective outputs 1-3.

An advantage of the electronic unit 600 is that the input voltage to the unit may vary, yet the proper voltages to the various circuits 1-3 of the unit are maintained substantially constant by employing the DC voltage boosts 1-3 (608, 610, and 612) in accordance with the invention. For example, the input voltage may vary from as low as 1 Volt to as high as 3 Volts. The variation may be due to a battery running low on power, or other factors such as line variations, etc. Although the input voltage to the electronic unit 600 may vary, the DC voltage boosts 1-3 (608, 610, and 612) maintains the supply voltages output 1-3 to the respective circuits 1-3 (602, 604, and 606) substantially constant for proper operations of these circuits.

Figure 7A illustrates a block/schematic diagram of an exemplary regulation circuit 700 for an inductive booster pump 702 in accordance with the invention. The regulation circuit 700 receives the output voltage of the booster pump 702 and provides a pulse width modulated control signal for driving the switching transistor of the boost pump 702 as described above with reference to DC voltage boost circuits 200, 300 and 400. In this exemplary embodiment, the regulation circuit 700 comprises a voltage divider 704 including resistors R1 and R2, a differential amplifier 706, a first comparator 708, a multiplexer 710, a ramp generator 714, a pulse width modulator 716, a second comparator 718, an inverter 720, an AND-gate 722, and a high voltage level shifter 724.

In operation, the output voltage of the booster pump 702 is applied to the voltage divider 704 to produce a lower proportional feedback voltage V_f . The feedback voltage V_f is applied to the differential amplifier 706 to produce a modulating voltage ref_{bias} proportional to difference between voltage V_f and a reference voltage ref_{12} . The voltage ref_{bias} serves as a modulating signal for the pulse width modulator 716. The reference voltage ref_{12} sets the output voltage of the booster pump.

The modulating voltage *refbias* is applied to the first comparator 708 for comparison with another reference voltage *ref675*. The first comparator 708 produces an input select signal *compout1* for the multiplexer 710. If the modulating voltage *refbias* is above the reference voltage *ref675*, the select signal *compout1* causes the multiplexer 710 to output modulating voltage *refbias*. If, on the other hand, the modulating voltage *refbias* is below the reference voltage *ref675*, the select signal *compout1* causes the multiplexer 710 to output the voltage *ref675*, which serves then as the modulating signal. This insures that modulating signal applied to the pulse width modulator 716 is not below the threshold voltage of the pulse width modulator 716.

The modulating signal *refbias* from the multiplexer 710 is applied to the pulse width modulator 716 along with a triangular wave signal generated by the ramp generator 714. The ramp generator 714 essentially integrates a square wave clock signal to produce the triangular wave signal. The pulse width modulator 716 is a comparator that compares the modulating signal *refbias* with the triangular wave signal. The output of the pulse width modulator 716 is a pulse modulated signal *Pwm* that is modulated by modulating signal *refbias*, which varies proportionally with the booster output voltage.

Figure 7B illustrates the waveforms involved in the pulse width modulating process of the regulation circuit 700 in accordance with the invention. The waveforms shown are the clock input to the ramp generator 714, the triangular waveform superimposed with three exemplary voltage levels for the modulating signal *refbias*, and corresponding output pulse modulated signals corresponding to the three exemplary modulating signal levels.

As it was previously discussed, the square wave clock signal is integrated by the ramp generator 714 to form the triangular waveform as shown in Figure 7B. The triangular waveform is applied to the positive input of the pulse width modulator comparator 716 and the modulating signal *refbias* is applied to the negative input of the comparator 716. If the voltage at any given time of the triangular waveform is greater than the modulating signal *refbias*, then the comparator 716 produces a substantially constant relatively high voltage. If, on the other hand, the voltage at any given time of the triangular waveform is less than the modulating signal *refbias*, then the comparator 716 produces a substantially constant relatively low voltage, preferably near zero (0) Volts.

Thus, as shown in Figure 7B, the higher the modulating voltage *refbias* is, the narrower the pulse width of the pulse width modulated signal *Pwm*. Conversely, the lower the modulating voltage *refbias*, the wider the pulse width of the pulse width modulated signal *Pwm*. Thus, the duty cycle of the modulating signal *Pwm* is modulated by the modulating signal *refbias*, which varies with the booster output voltage. Accordingly, when the booster output voltage drops, the duty cycle of the pulse modulated signal increases. This action causes the switching transistor to "turn ON" for a longer time, which causes more energy to be transferred to the output capacitor of the booster 702. This raises the booster output voltage to compensate for its initial drop. Conversely, when the booster output voltage rises, the duty cycle of the pulse modulated signal decreases. This action causes the pull down transistor to "turn ON" for a shorter time, which causes less energy to be transferred to the output capacitor of the booster 702. This lowers the booster output voltage to compensate for its initial rise.

Referring back to Figure 7A, the pulse width modulated signal *Pwm* from the pulse width modulator 716 is applied to an input of the AND-gate 722. The second comparator 718 compares the modulating voltage *refbias* with the reference voltage *ref12*, and generates an enabling signal to the AND-gate 722 by way of the inverter 720 if the reference voltage *ref12* is greater than the modulating voltage *refbias*. Or, conversely, generates a disabling signal to the AND-gate 722 if the modulating voltage *refbias* is greater than the reference voltage *ref12*. This disables the regulation circuit 700 if the modulating voltage *refbias* is greater than the reference voltage *ref12*. This is done to prevent the boost output voltage from exceeding 150 mVolts above the desired boost voltage (e.g. 6 Volts) at all process skew and temperature corners. The pulse width modulated voltage *refbias* is applied to the high voltage level shifter 724 (when the AND-gate 722 is enabled) to increase it to a sufficient level to drive the switching transistor of the booster pump 702. The level shifter 724 uses the booster output voltage to accomplish this.

Figure 8A illustrates a schematic/block diagram of another exemplary regulation circuit 800 useful for regulating the output voltage of an inductive booster pump 802 in accordance with the invention. The regulation circuit 800 receives the output voltage of the booster pump 802 and provides a pulse width modulated control signal for driving the switching transistor of the boost pump 802 as described above with reference to DC

voltage boost circuits 200, 300 and 400. In this exemplary embodiment, the regulation circuit 800 comprises a voltage divider 804, a bias generator 806, a ramp generator 808, a pulse width modulator comparator 810, and a high voltage level shifter 812. The ramp generator 808, in turn, comprises a transmission gate 814, a capacitor 816, an inverter 818, and a transistor 820.

In operation, the output voltage of the booster pump 802 is applied to the voltage divider 804 to produce a lower proportional feedback voltage V_{fb} . The feedback voltage V_{fb} is applied to the bias generator 806 which is a low gain differential amplifier. The bias generator 806 generates complimentary positive (pbias) and negative (nbias) outputs that vary with the difference between the feedback voltage V_{fb} and a reference voltage $Ref1$. The reference voltage $Ref1$ is used to set the output of the booster pump 802 to a desired voltage level.

The complimentary positive (pbias) and negative (nbias) outputs are applied to the gates of the p-device and n-device of the transmission gate 814, respectively. A clock signal, having a duty cycle of about 75 percent, is applied to the transmission gate 814. The transmission gate 814 in combination with the capacitor 816 operate to integrate the clock signal to form a sawtooth waveform $Ramp$. The rise time of the sawtooth waveform $Ramp$ varies inversely with the degree to which the transmission gate 814 is turned on, which is a function of the output voltage of the booster pump 802. The inverter 818 in combination with the transistor 820 discharges the capacitor 816 when the clock goes low.

The sawtooth waveform $Ramp$ is applied to the positive input of the pulse width modulating comparator 810. The comparator 810 compares the sawtooth waveform $Ramp$ with a substantially constant reference voltage $Ref2$. Based on the comparison made by the comparator 810, the comparator 810 generates a pulse modulated control signal Pwm_clk that has a duty cycle that varies inversely with the output voltage of the booster pump 802. The pulse modulated control signal drives the switching transistor of the booster pump 802.

Figure 8B illustrates the waveforms involved in the pulse width modulating process of the regulation circuit 800 in accordance with the invention. The waveforms shown are the clock input to the ramp generator 808, three sawtooth waveforms $Ramp$ corresponding to three different output voltages of the boost pump superimposed with the substantially constant reference voltage $Ref2$, and the resulting pulse width modulated

control signal *Pwm_clk*. Since the sawtooth waveform *Ramp* is applied to the positive input and the reference voltage *Ref2* is applied to the negative input of the comparator 810, the comparator 810 produces a relatively high output voltage when the sawtooth waveform *Ramp* is greater than the reference voltage *Ref2*, and produces a relatively low output voltage when the sawtooth waveform *Ramp* is less than the reference voltage *Ref2*.

Thus, as shown in Figure 8B, the pulse width of the pulse modulated signal is a function of the time the sawtooth waveform *Ramp* is greater than the reference voltage *Ref2*. Since the slope of the sawtooth waveform *Ramp* varies inversely with the output voltage of the boost pump 802, the greater the boost output voltage, the less time the sawtooth waveform *Ramp* is above the reference voltage *Ref2*, and consequently, the smaller the pulse width of the resulting pulse modulated signal. Conversely, the lesser the boost output voltage, the more time the sawtooth waveform *Ramp* is above the reference voltage *Ref2*, and consequently, the larger the pulse width of the pulse modulated signal. Thus, the duty cycle of the pulse width modulated signal varies inversely with the boost output voltage.

The pulse width modulated signal *Pwm_clk* is applied to the high voltage level shifter to increase the pulse modulated signal voltage to a sufficient level to drive the switching transistor of the boost pump 802. The pulse width modulated signal *Pwm_clk* regulates the boost pump 802 so that it produces a substantially constant desired output voltage. The regulation is as follows. When the booster output voltage drops, the duty cycle of the pulse modulated signal *Pwm_clk* increases. This action causes the switching transistor to "turn ON" for a longer time, which causes more energy to be transferred to the output capacitor of the booster 802. This raises the booster output voltage to compensate for its initial drop. Conversely, when the booster output voltage rises, the duty cycle of the pulse modulated signal *Pwm_clk* decreases. This action causes the switching transistor to "turn ON" for a shorter time, which causes less energy to be transferred to the output capacitor of the booster 802. This lowers the booster output voltage to compensate for its initial rise.

Figure 9A illustrates a schematic/block diagram of yet another exemplary regulation circuit 900 useful for regulating the output voltage of an inductive booster pump 902 in accordance with the invention. The regulation circuit 900 receives the output voltage of the booster pump 902 and provides a pulse width modulated control signal for

driving the switching transistor of the boost pump 902 as described above with reference to DC boost circuits 200, 300 and 400. In this exemplary embodiment, the regulation circuit 900 comprises a voltage divider 904, a comparator 906, a 3-bit counter 908, a logic circuit 910, and a high voltage level shifter 912.

5 In operation, the output voltage of the booster pump 902 is applied to the voltage divider 904 to produce a lower proportional feedback voltage V_{fb} . The feedback voltage V_{fb} is applied to the positive input of the comparator 906. The comparator 906 compares the feedback voltage V_{fb} with a reference voltage Ref , and produces a relatively high voltage if the feedback voltage V_{fb} is greater than the reference voltage Ref , and a
10 relatively low voltage if the feedback voltage V_{fb} is lower than the reference voltage Ref . The reference voltage Ref is used to set the output of the booster pump 902 to a desired voltage level.

The comparator output is applied to the Reset input of the 3-bit counter 908. A clock signal drives the 3-bit counter 908 to repetitiously count from binary 0 to binary 7
15 and produce the count at outputs Bit 0,1,2 (Bit 2 being the least significant digit and Bit 0 being the most significant digit of the count). The counter outputs are applied to the logic circuit which produces a pulse width modulated signal pwm_clk in accordance with the truth table shown in Figure 9B. That is, it produces a high for the count 1-6, and a low for the count 0 and 7.

20 Figure 9C illustrates the waveforms involved in the pulse width modulating process of the regulation circuit 900 in accordance with the invention. The count periodically cycles from binary 0 to binary 7. The clock causes the 3-bit counter 908 to increase the count by each every pulse (leading or trailing edge) of the clock. The pulse width modulated signal generated by the logic circuit 910 is high for binary input 1-6 and
25 a low for binary input 0 and 7. The signal applied to the Reset input of the 3-bit counter causes the counter to produce a count of 0 when the Reset signal is high, thereby causing the pulse modulated signal pwm_clk to go low, or remain low if the Reset signal remains high. The pulse modulated signal pwm_clk is applied to the high voltage level shifter 912 to boost its power to sufficient level to drive the switching transistor of the booster pump
30 902.

The regulation of the booster pump 902 operates as follows. During normal operations where the output voltage is at substantially the desired output voltage, the Reset

signal remains low, i.e. the feedback voltage V_{fb} is lower than the reference voltage Ref . Since it has been determined that the boost pump 902 operates most efficiently at about a duty cycle of 75 percent, the mere cycling of the 3-bit counter produces a pulse modulated signal pwm_clk that has a duty cycle of 75 percent. That is because there are 6 high states and two low states as the counter cycles from binary 0 to binary 7 (See Figure 9B). If the booster output voltage rises above the desired output voltage, the feedback voltage V_{fb} rises above the reference voltage Ref , which causes the comparator 906 to generate a high Reset signal. The high Reset signal causes the counter 908 to reset, which in turn, prematurely causes the pulse modulated signal to go low. This reduces the duty cycle of the pulse modulated signal pwm_clk , which causes the output booster voltage to drop to compensate for its initial rise.

The regulation circuits described can be used to regulate the output voltages of the inductive DC boost circuits described herein. In addition, they can also be used to regulate the output voltages of other DC boost circuits, such as the capacitive charge pump boost circuit previously described.

In the foregoing specification, the invention has been described with reference to specific embodiments thereof. It will, however, be evident that various modifications and changes may be made thereto departing from the broader spirit and scope of the invention. The specification and drawings are, accordingly, to be regarded in an illustrative rather than a restrictive sense.

What is claimed is:

1. A dc voltage boost circuit comprising:

a booster pump for generating a dc output voltage in response to an input dc voltage and a pulse width modulated control signal;

a regulation circuit for generating said pulse width modulated control signal whose duty cycle varies inversely with said dc output voltage, wherein said regulation circuit comprises a waveform generator for generating a triangular waveform and a comparator for producing said pulse width modulated control signal by comparing said triangular waveform with a modulating voltage that varies inversely with said dc output voltage; and

a gate for blocking the transmission of said pulse width control signal to said booster pump if said output voltage exceeds a predetermined threshold.

2. A dc voltage boost circuit comprising:

a booster pump for generating a dc output voltage in response to an input dc voltage and a pulse width modulated control signal;

a regulation circuit for generating said pulse width modulated control signal whose duty cycle varies inversely with said dc output voltage, wherein said regulation circuit comprises a waveform generator for generating a triangular waveform and a comparator for producing said pulse width modulated control signal by comparing said triangular waveform with a modulating voltage that varies inversely with said dc output voltage; and

a multiplexer for either gating said modulating voltage to said comparator if said output voltage is above a predetermined threshold or gating a substantially constant voltage to said comparator if said output voltage is below said predetermined threshold.

3. A dc voltage boost circuit comprising:

a booster pump for generating a dc output voltage in response to an input dc voltage and a pulse width modulated control signal; and

a regulation circuit for generating said pulse width modulated control signal whose duty cycle varies inversely with said dc output voltage, wherein said regulation circuit comprises:

a waveform generator for generating a sawtooth waveform whose rise time varies inversely with said output voltage; and

a comparator for producing said pulse width modulated control signal by comparing said sawtooth waveform with a substantially constant voltage.

4. The dc voltage boost circuit of claim 3, comprises an integrator for integrating a substantially square waveform clock to form said sawtooth waveform.

5. The dc voltage boost circuit of claim 4, wherein said integrator comprises:

a variable resistor whose resistance varies with said output voltage; and

an integrating capacitor.

6. The dc voltage boost circuit of claim 5, wherein said variable resistor comprises a transmission gate.

7. The dc voltage boost circuit of claim 5, wherein said regulation circuit further includes a discharging transistor for discharging the integrating capacitor when the clock goes low.

8. A dc voltage boost circuit comprising:

a booster pump for generating a dc output voltage in response to an input dc voltage and a pulse width modulated control signal;

a regulation circuit for generating said pulse width modulated control signal whose duty cycle varies inversely with said dc output voltage, wherein said regulation circuit comprises:

a counter for generating a count that sequentially cycles between a low number and a high number, wherein said count is reset in response to changes in said output voltage;

a logic circuit for generating said pulse width modulated control signal from said count.

9. The dc voltage boost circuit of claim 8, further including a comparator for producing a reset signal for resetting said counter if said output voltage exceeds a predetermined level.

10. An inductive voltage boost circuit comprising:

an inductive booster pump for generating an output voltage in response to an input voltage and a pulse width modulated control signal;

a regulation circuit for generating said pulse width modulated control signal whose duty cycle varies inversely with said output voltage, wherein said regulation circuit comprises a waveform generator for generating a triangular waveform and a comparator for producing said pulse width modulated control signal by comparing said triangular waveform with a modulating voltage that varies in proportion with said output voltage; and

a gate for blocking the transmission of said pulse width modulated control signal to said booster pump if said output voltage exceeds a predetermined threshold.

11. An inductive voltage boost circuit comprising:

an inductive booster pump for generating an output voltage in response to an input voltage and a pulse width modulated control signal;

a regulation circuit for generating said pulse width modulated control signal whose duty cycle varies inversely with said output voltage, wherein said regulation circuit comprises a waveform generator for generating a triangular waveform and a comparator for producing said pulse width modulated control signal by comparing said triangular waveform with a modulating voltage that varies in proportion with said output voltage; and

a multiplexer for either gating said modulating voltage to said comparator if said output voltage is

above a predetermined threshold or gating a substantially constant voltage to said comparator if said output voltage is below said predetermined threshold.

12. An inductive boost circuit comprising:

an inductive booster pump for generating an output voltage in response to an input voltage and a pulse width modulated control signal; and

a regulation circuit for generating said pulse width modulated control signal whose duty cycle varies inversely with said output voltage, wherein said regulation circuit comprises:

a waveform generator for generating a sawtooth waveform whose rise time varies inversely with said output voltage; and

a comparator for producing said pulse width modulated control signal by comparing said sawtooth waveform with a substantially constant voltage.

13. The inductive voltage boost circuit of claim 12, comprises an integrator for integrating a substantially square waveform clock to form said sawtooth waveform.

14. The inductive voltage boost circuit of claim 13, wherein said integrator comprises:

a variable resistor whose resistance varies inversely with said output voltage; and

an integrating capacitor.

15. The inductive voltage boost circuit of claim 14, wherein said variable resistor comprises a transmission gate.

16. The inductive voltage boost circuit of claim 14, wherein said regulation circuit further includes a discharging transistor for discharging the integrating capacitor when the clock goes low.

17. An inductive boost circuit comprising:

an inductive booster pump for generating an output voltage in response to an input voltage and a pulse width modulated control signal; and

a regulation circuit for generating said pulse width modulated control signal whose duty cycle varies inversely with said output voltage, wherein said regulation circuit comprises:

a counter for generating a count that sequentially cycles between a low number and a high number, wherein said count is reset in response to changes in said output voltage;

a logic circuit for generating said pulse width modulated control signal from said count.

18. The inductive voltage boost circuit of claim 17, further including a comparator for producing a reset signal for resetting said counter if said output voltage exceeds a predetermined level.

19. A dc voltage boost circuit comprising:

an inductive element;

a switching device that uses an input voltage to periodically cause current to flow through said inductive element in response to a pulse width modulated control signal, wherein said inductive element stores a finite amount of energy each time current is passed therethrough;

a capacitive element to accumulate a plurality of said finite energy stored in said inductive element in the form of an output voltage;

a regulation circuit to generate said pulse width modulated control signal whose duty cycle varies inversely with said output voltage, wherein said regulation circuit comprises a waveform generator to generate a triangular waveform and a comparator to produce said pulse width modulated control signal by comparing said triangular waveform with a modulating voltage that varies inversely with said dc output voltage; and

a gate to block the transmission of said pulse width modulated control signal to said booster pump if said output voltage exceeds a predetermined threshold.

20. A dc voltage boost circuit comprising:

an inductive element;

a switching device that uses an input voltage to periodically cause current to flow through said inductive element in response to a pulse width modulated control signal, wherein said inductive element stores a finite amount of energy each time current is passed therethrough;

a capacitive element to accumulate a plurality of said finite energy stored in said inductive element in the form of an output voltage;

a regulation circuit to generate said pulse width modulated control signal whose duty cycle varies inversely with said output voltage, wherein said regulation circuit comprises a waveform generator to generate a triangular waveform and a comparator to produce said pulse width modulated control signal by comparing said triangular waveform with a modulating voltage that varies inversely with said dc output voltage; and

a multiplexer to either gate said modulating voltage to said comparator if said output voltage is above a predetermined threshold or gate a substantially constant voltage to said comparator if said output voltage is below said predetermined threshold.

21. A dc voltage boost circuit comprising:

an inductive element;

a switching device that uses an input voltage to periodically cause current to flow through said inductive element in response to a pulse width modulated control signal, wherein said inductive element stores a finite amount of energy each time current is passed therethrough;

a capacitive element to accumulate a plurality of said finite energy stored in said inductive element in the form of an output voltage;

a regulation circuit to generate said pulse width modulated control signal whose duty cycle varies inversely with said output voltage, wherein said regulation circuit comprises:

a waveform generator to generate a sawtooth waveform whose rise time varies inversely with said output voltage; and

a comparator to produce said pulse width modulated control signal by comparing said sawtooth waveform with a substantially constant voltage.

22. The dc voltage boost circuit of claim 21, comprises an integrator to integrate a substantially square waveform clock to form said sawtooth waveform.

23. The dc voltage boost circuit of claim 22, wherein said integrator comprises:

a variable resistor whose resistance varies with said output voltage; and

an integrating capacitor.

24. The dc voltage boost circuit of claim 23, wherein said variable resistor comprises a transmission gate.

25. The dc voltage boost circuit of claim 23, wherein said regulation circuit further includes a discharging transistor to discharge the integrating capacitor when the clock goes low.

26. A dc voltage boost circuit comprising:

an inductive element;

a switching device that uses an input voltage to periodically cause current to flow through said inductive element in response to a pulse width modulated control signal, wherein said inductive element stores a finite amount of energy each time current is passed therethrough;

a capacitive element to accumulate a plurality of said finite energy stored in said inductive element in the form of an output voltage;

a regulation circuit to generate said pulse width modulated control signal whose duty cycle varies inversely with said output voltage, wherein said regulation circuit comprises:

a counter to generate a count that sequentially cycles between a low number and a high number, wherein said count is reset in response to changes in said output voltage;

a logic circuit to generate said pulse width modulated control signal from said count.

27. The dc voltage boost circuit of claim 26, further including a comparator to produce a reset signal for resetting said counter if said output voltage exceeds a predetermined level.

28. A method comprising:

sampling an output voltage; and

generating a control signal that cycles with a duty cycle that varies inversely with said output voltage,

wherein said control signal regulates said output voltage, wherein said producing said control signal comprises modulating a rise time of a sawtooth waveform and comparing said modulated sawtooth waveform with a substantially constant voltage.

29. A method comprising:

sampling an output voltage; and

generating a control signal that cycles with a duty cycle that varies inversely with said output voltage, wherein said control signal regulates said output voltage, wherein said producing comprises generating a count that cycles between a low number and a high number, and resetting said count if said output voltage exceeds a threshold voltage.